2SC2497, 2SC2497A

Silicon NPN epitaxial planar type

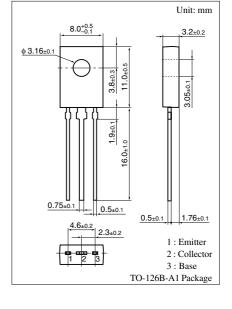
For low-frequency power amplification Complementary to 2SA1096 and 2SA1096A

■ Features

- ullet High collector to emitter voltage V_{CEO}
- TO-126B package which requires no insulation plate for installation to the heat sink

■ Absolute Maximum Ratings $T_C = 25$ °C

3 6					
Parameter		Symbol	Rating	Unit	
Collector to base voltage		V_{CBO}	70	V	
Collector to	2SC2497	V_{CEO}	50	V	
emitter voltage	2SC2497A		60		
Emitter to base voltage		V_{EBO}	5	V	
Peak collector current		I_{CP}	3	A	
Collector current		I_C	1.5	A	
Collector power dissipation		P _C	1.2 *1	W	
			5 *2		
Junction temperature		T _j	150	°C	
Storage temperature		T _{stg}	-55 to +150	°C	



Note) *1: Without heat sink

*2: With a $100 \times 100 \times 2$ mm A1 heat sink

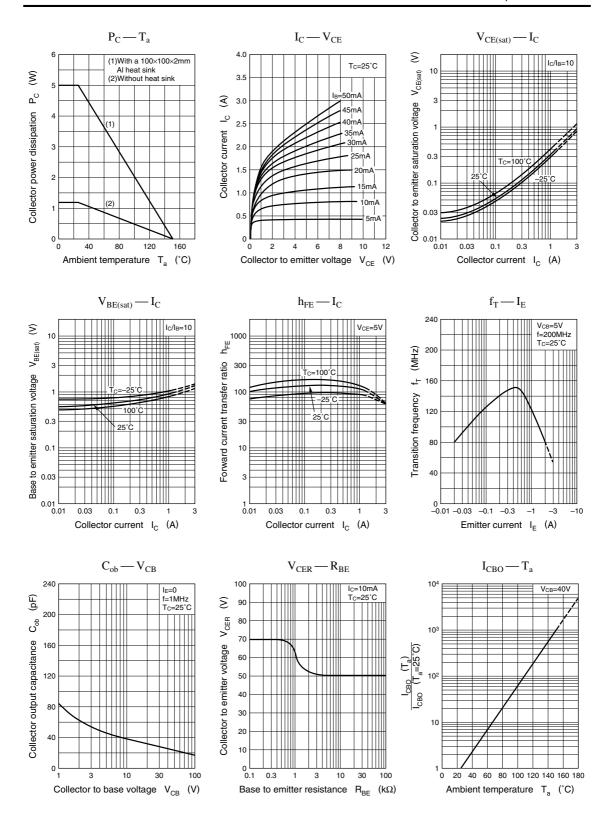
■ Electrical Characteristics $T_C = 25$ °C

Parameter	į	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff current	t	I_{CBO}	$V_{CB} = 20 \text{ V}, I_E = 0$			1	μΑ
		I_{CEO}	$V_{CE} = 10 \text{ V}, I_B = 0$			100	μΑ
Emitter cutoff current		I_{EBO}	$V_{EB} = 5 \text{ V}, I_{C} = 0$			10	μΑ
Collector to base voltage	ge	V_{CBO}	$I_C = 1 \text{ mA}, I_E = 0$	70			V
Collector to emitter	2SC2497	V_{CEO}	$I_C = 2 \text{ mA}, I_B = 0$	50			V
voltage	2SC2497A			60			
Forward current transfe	r ratio *	h_{FE}	$V_{CE} = 5 \text{ V}, I_{C} = 1 \text{ A}$	80		220	
Collector to emitter satu	ration voltage	V _{CE(sat)}	$I_C = 1.5 \text{ A}, I_B = 0.15 \text{ A}$			1	V
Base to emitter saturati	on voltage	V _{BE(sat)}	$I_C = 1.5 \text{ A}, I_B = 0.15 \text{ A}$			1.5	V
Transition frequency		f_T	$V_{CB} = 5 \text{ V}, I_E = -0.5 \text{ A}, f = 200 \text{ MHz}$		150		MHz
Collector output capaci	tance	C_{ob}	$V_{CB} = 20 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		35		pF

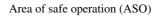
Note) *: Rank classification

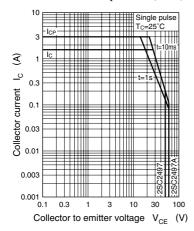
Rank	R	S
h_{FE}	80 to 160	120 to 220

188 Panasonic



Panasonic 189





190 Panasonic

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